



Docket No. 01-234

I THE UNITED STATES PATENT AND TRADEMARK OFFICE

Commissioner of Patents and Trademarks Washington, D.C. 20231

Re: Inventors:

Colin D. Yates, Nicholas F. Pasch, and Nicholas K. Eib

Title:

ALIGNMENT PROCESS FOR INTEGRATED CIRCUIT STRUCTURES ON SEMICONDUCTOR SUBSTRATE USING SCATTEROMETRY MEASUREMENTS OF LATENT IMAGES IN SPACED

APART TEST FIELDS ON SUBSTRATE

Transmitted here	with is	the	patent	application	identified	above,	including

- X Specification, claims and abstract, totaling 13 pages.
- X Drawings totaling 3 pages, Formal X Informal.
- X Signed Declaration and Power of Attorney.
- X Request and Certification Under 35 U.S.C. 122(b)(2)(B)(i).
 - Information Disclosure Statement and 4 accompanying disclosures.

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识 Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	19	-20=	0	x \$18.00	\$0.00
# #Independent Claims	3	-3=	0	x \$84.00	\$0.00
Multiple Dependent Claim Fee (for one or more) \$280.00					\$0.00
Pasic Filing Fee \$740.00					\$740.00
TOTAL FEES					\$740.00

	Attached is a che	ck in the	amount of \$			•		
<u>x</u>	The Commissioner 12-2252	is hereby —·	authorized to	charge \$	740.00	to Deposit	Account	No.

- X The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. <u>12-2252</u>. A duplicate copy of this transmittal is enclosed.
- XX Please address all future correspondence to:

Sandeep Jaggi, Chief IP Counsel Intellectual Property Law Department LSI Logic Corporation 1551 McCarthy Boulevard M/S D-106 Milpitas, CA 95035

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Assistant Commissioner for Patents, U.S. Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

Express Mail Receipt No. <u>ET662218698US</u>

Date of Deposit November 30, 2001

Signature for staylo

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PATENT TRADEMARK OFFICE

Respectfully submitted,

John P. Taylor Patent Attorney

Registration No. 22,369

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REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

		Colin Yates et al.
Title	ALIGNMENT P STRUCTURES	ROCESS FOR INTEGRATED CIRCUIT ON SEMICONDUCTOR SUBSTRATE
Atty Docket Number		01-234

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

November 30, 2001

Date

Signature

John P. Taylor

Typed or printed name

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).